

K214-E-VB Datasheet N-Channel 150-V (D-S) 175 °C MOSFET

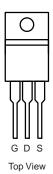
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
150	0.030 at V _{GS} = 10 V	50		
130	0.033 at V _{GS} = 6 V	45		

FEATURES

- Trench Power MOSFETs
- 175 °C Junction Temperature
- New Low Thermal Resistance Package
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC

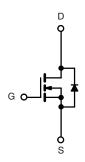


TO-220AB



APPLICATIONS

Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	150	V	
Gate-Source Voltage		V _{GS}	± 20	7 v	
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	I-	50		
Continuous Diain Current (1) = 175 C)	T _C = 125 °C	l _D	35		
Pulsed Drain Current		I _{DM}	150	_ A	
Avalanche Current		I _{AR}	50		
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	80	mJ	
M	T _C = 25 °C	В	166 ^b	14/	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	$ P_D$ $-$	3.75	W	
Operating Junction and Storage Temperature Range		T _J , T _{sta}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.9	- °C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

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SPECIFICATIONS $T_J = 25^{\circ}$	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		1001001110110		.,,,,		<u> </u>	
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	150				
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 120 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 120 V, V _{GS} = 0 V, T _J = 125 °C			50 μA		
		V _{DS} = 120 V, V _{GS} = 0 V, T _J = 175 °C			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	80			Α	
	` '	V _{GS} = 10 V, I _D = 15 A		0.030			
	5	V _{GS} = 6 V, I _D = 10 A		0.033		_	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C		0.076		Ω	
		V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C		0.100		1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	10			S	
Dynamic ^b				<u> </u>			
Input Capacitance	C _{iss}			2500		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		290			
Reverse Transfer Capacitance	C _{rss}			190			
Gate Resistance	R_{g}			2		Ω	
Total Gate Charge ^c	Q_g			38	60		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 40 \text{ A}$		13		nC	
Gate-Drain Charge ^c	Q_{gd}			13			
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	$V_{DD} = 75 \text{ V}, R_L = 1.80 \Omega$		130	200	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 40 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		30	45		
Fall Time ^c	t _f			90	140		
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b					
Continuous Current	IS				40	А	
Pulsed Current	I _{SM}				80		
Forward Voltage ^a	V_{SD}	I _F = 40 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			100	150	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 40 A, dl/dt = 100 A/μs		5	8	Α	
Reverse Recovery Charge	Q _{rr}			0.25	0.6	μC	

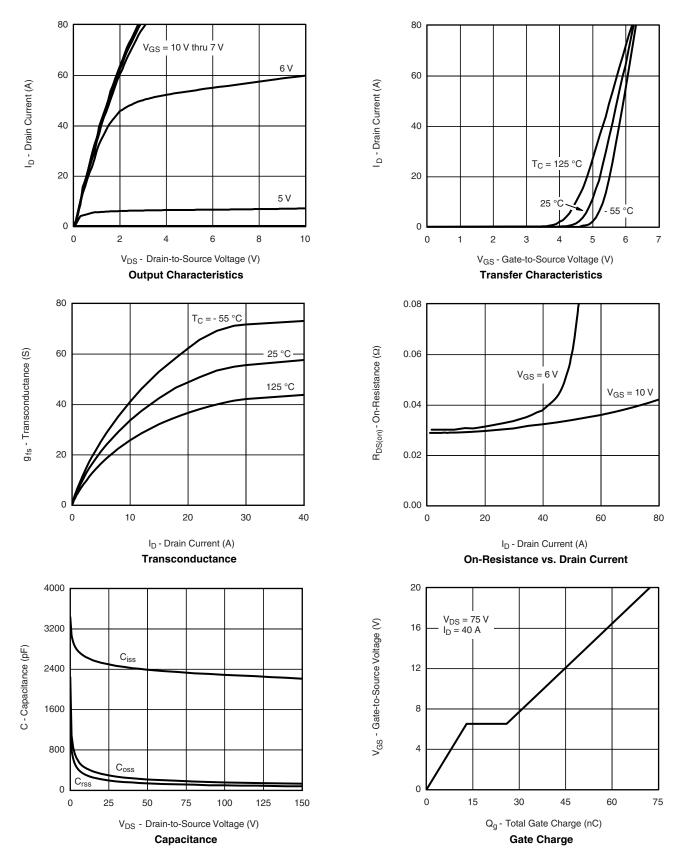
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

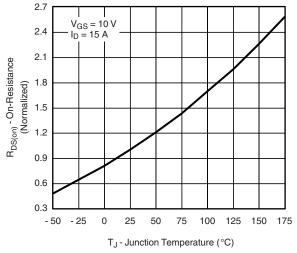


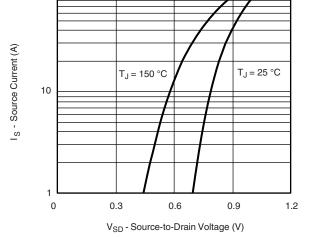
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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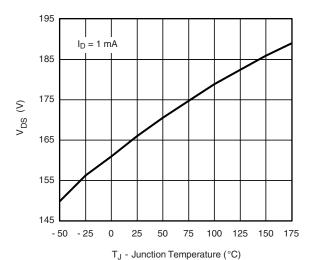




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On-Resistance vs. Junction Temperature

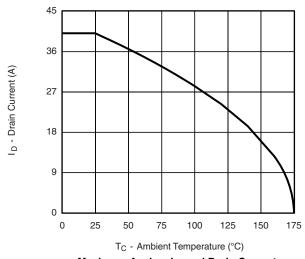
Source-Drain Diode Forward Voltage

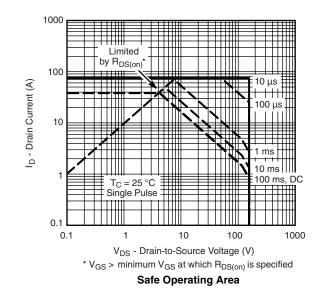


Drain Source Breakdown vs. Junction Temperature

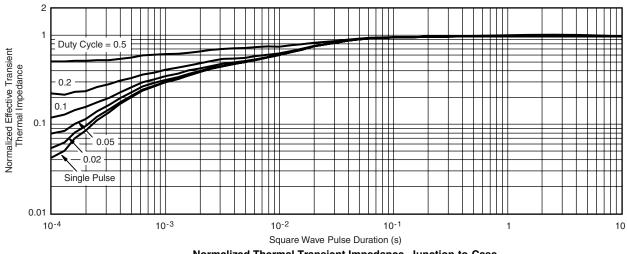


THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

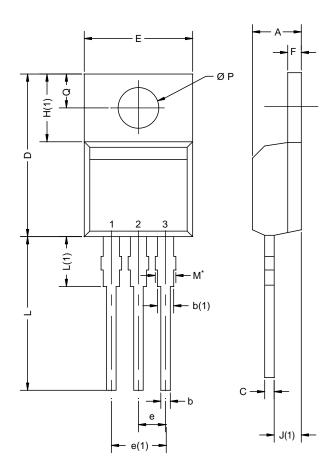
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	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12					

DWG: 5471

Notes

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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